

AOTF7N60FD

600V, 7A N-Channel MOSFET with Fast Recovery Diode

General Description

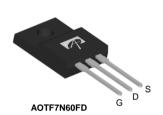
The AOTF7N60FD has been fabricated using an advanced high voltage MOSFET process that is designed to deliver high levels of performance and robustness in popular AC-DC applications. By providing low $R_{\rm DS(on)},\,C_{\rm iss}$ and $C_{\rm rss}$ along with guaranteed avalanche capability this part can be adopted quickly into new and existing offline power supply designs.

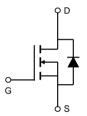
Product Summary

100% UIS Tested 100% R_g Tested



Top View TO-220F





Parameter		Symbol	AOTF7N60FD	Units
Drain-Source Voltage		V_{DS}	600	V
Gate-Source Voltage		V_{GS}	±30	V
Continuous Drain	T _C =25°C		7*	
Current	T _C =100°C	I _D	4.7*	Α
Pulsed Drain Current ^C		I _{DM}	24	
Avalanche Current ^C		I _{AR}	3.5	А
Repetitive avalanche energy ^C		E _{AR}	184	mJ
Single pulsed avalanche energy ^G		E _{AS}	368	mJ
Peak diode recovery dv/dt		dv/dt	5	V/ns
	T _C =25°C	P _D	39	W
Power Dissipation ^B	Derate above 25°C	T D	0.3	W/°C
Junction and Storage Temperature Range		T _J , T _{STG}	-55 to 150	°C
Maximum lead temper	rature for soldering			
purpose, 1/8" from case for 5 seconds		T_L	300	°C
Thermal Characteris	tics			
Parameter		Symbol	AOTF7N60FD	Units
Maximum Junction-to-Ambient A,D		$R_{\theta JA}$	65	°C/W
Maximum Junction-to-Case		$R_{ heta JC}$	3.25	°C/W

^{*} Drain current limited by maximum junction temperature.



Electrical Characteristics (T_{.I}=25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Тур	Max	Units	
STATIC F	PARAMETERS						
BV _{DSS}	Drain-Source Breakdown Voltage	I _D =10mA, V _{GS} =0V, T _J =25°C	600				
		$I_D=10$ mA, $V_{GS}=0$ V, $T_J=150$ °C		700		V	
BV _{DSS} /∆TJ	Breakdown Voltage Temperature Coefficient	I _D =10mA, V _{GS} =0V		0.68		V/°C	
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =600V, V _{GS} =0V			10	μА	
		V _{DS} =480V, T _J =125°C			100		
I _{GSS}	Gate-Body leakage current	V_{DS} =0V, V_{GS} =±30V			±100	nA	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = 5V, I_{D} = 250 \mu A$	2.5	3.3	4.2	V	
R _{DS(ON)}	Static Drain-Source On-Resistance	V_{GS} =10V, I_D =3.5A		1.2	1.45	Ω	
g _{FS}	Forward Transconductance	V_{DS} =40V, I_{D} =3.5A		7		S	
V_{SD}	Diode Forward Voltage	I _S =7A,V _{GS} =0V		1.03	1.6	V	
I _S	Maximum Body-Diode Continuous Current				7	Α	
I _{SM}	Maximum Body-Diode Pulsed Current				24	Α	
DYNAMIC	PARAMETERS						
C _{iss}	Input Capacitance		600	826	995	pF	
Coss	Output Capacitance	V_{GS} =0V, V_{DS} =25V, f=1MHz	60	86	115	pF	
C_{rss}	Reverse Transfer Capacitance		4.5	7.9	11.5	pF	
R_g	Gate resistance	V_{GS} =0V, V_{DS} =0V, f=1MHz	2	4	6	Ω	
SWITCHI	NG PARAMETERS						
Q_g	Total Gate Charge		15	20	25	nC	
Q_{gs}	Gate Source Charge	V_{GS} =10V, V_{DS} =480V, I_{D} =7A		3.6		nC	
Q_{gd}	Gate Drain Charge			7.7		nC	
t _{D(on)}	Turn-On DelayTime			24		ns	
t _r	Turn-On Rise Time	V_{GS} =10V, V_{DS} =300V, I_{D} =7A,		55		ns	
t _{D(off)}	Turn-Off DelayTime	$R_G=25\Omega$		56		ns	
t _f	Turn-Off Fall Time			42		ns	
t _{rr}	Body Diode Reverse Recovery Time	I_F =7A,dI/dt=100A/ μ s, V_{DS} =100V		76	130	ns	
Q_{rr}	Body Diode Reverse Recovery Charge	_E I _F =7A,dI/dt=100A/μs,V _{DS} =100V		0.3	0.5	μС	

- A. The value of R $_{\theta JA}$ is measured with the device in a still air environment with T $_A$ =25 $^{\circ}$ C.
- B. The power dissipation P_D is based on $T_{J(MAX)}$ =150° C, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heatsinking is used.
- C. Repetitive rating, pulse width limited by junction temperature $T_{J(MAX)}$ =150° C, Ratings are based on low frequency and duty cycles to keep initial T_{J} =25° C.
- D. The R $_{\theta JA}$ is the sum of the thermal impedance from junction to case R $_{\theta JC}$ and case to ambient.
- E. The static characteristics in Figures 1 to 6 are obtained using <300 μs pulses, duty cycle 0.5% max.
- F. These curves are based on the junction-to-case thermal impedance which is measured with the device mounted to a large heatsink, assuming a maximum junction temperature of T_{J(MAX)}=150° C. The SOA curve provides a single pulse rating.
- G. L=60mH, I_{AS} =3.5A, V_{DD} =150V, R_{G} =25 Ω , Starting $T_{.i}$ =25 $^{\circ}$ C

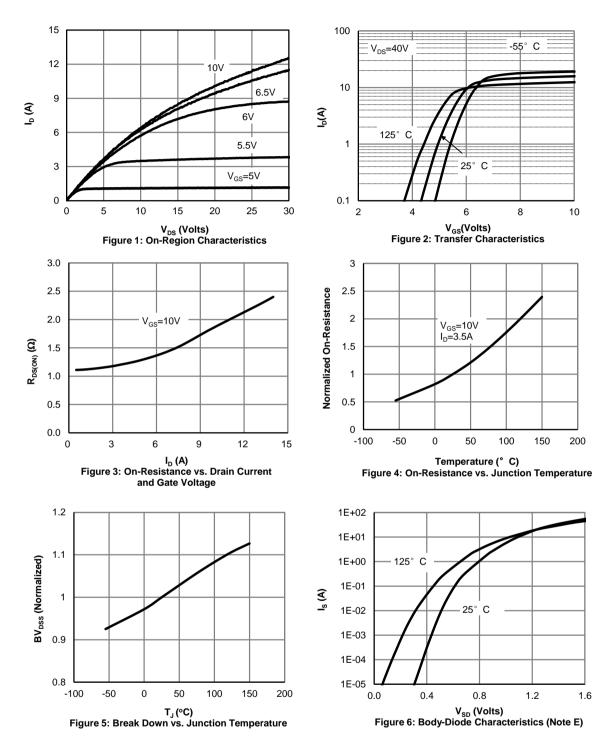
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Rev.3.1: May 2024 **www.aosmd.com** Page 2 of 6

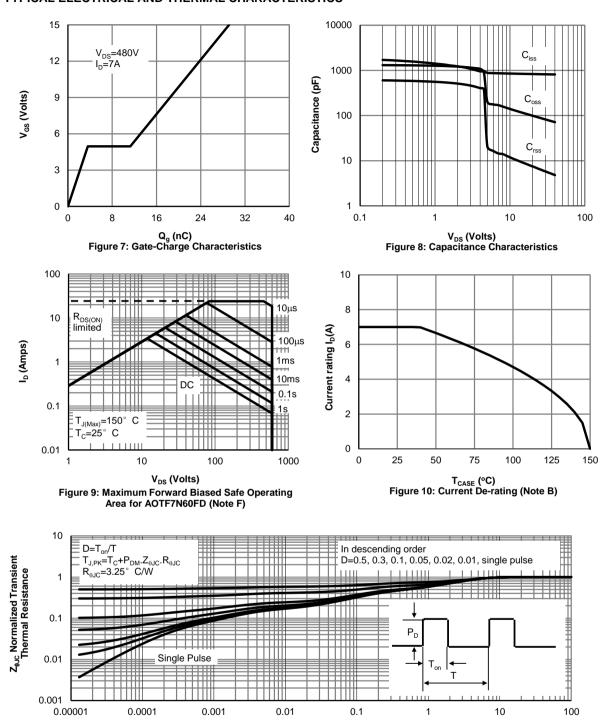


TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS





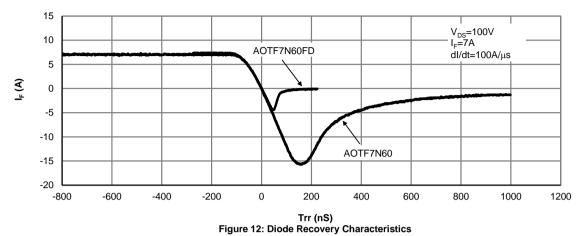
TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS



Pulse Width (s)
Figure 11: Normalized Maximum Transient Thermal Impedance for AOTF7N60FD (Note F)

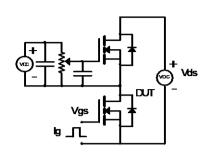


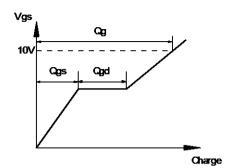
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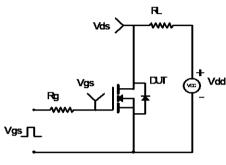


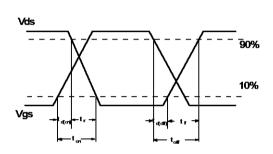
Gate Charge Test Circuit & Waveform



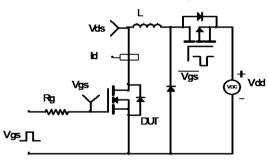


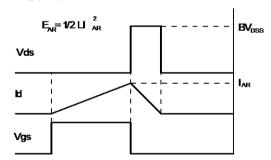
Resistive Switching Test Circuit & Waveforms





Unclamped Inductive Switching (UIS) Test Circuit & Waveforms





Diode Recovery Test Circuit & Waveforms

